

SSC8037GS6A

P-Channel Enhancement Mode MOSFET

Features

| V _{DS} | V _{GS} | R _{DS(ON)} Typ. | l _D |
|-----------------|-----------------|--------------------------|----------------|
| -30V | +20V | 21mΩ@-10V | -8A |
| | <u> </u> | 28mΩ@-4V5 | -0/ |

Description

The SSC8037GS6A is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in load switch, DCDC conversion and battery isolation.

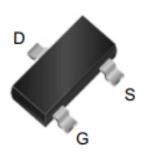
Applications

- Load Switch
- DCDC Conversion
- Battery Isolation

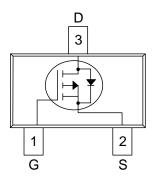
Ordering Information

| Device | Package | Shipping |
|-------------|-----------|-----------|
| SSC8037GS6A | SOT-23-3L | 3000/Reel |

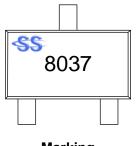
Pin configuration



SOT-23-3L



Pin Configuration (Top View)



<u>Marking</u>



➤ Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

| Symbol | Parameter | Ratings | Unit |
|------------------|--|---------|---------------|
| V _{DSS} | Drain-to-Source Voltage | -30 | V |
| V _{GSS} | Gate-to-Source Voltage | ±20 | V |
| I _D | Continuous Drain Current a | -8 | Α |
| I _{DM} | Pulsed Drain Current b | -28 | Α |
| P _D | Power Dissipation ^a | 2.2 | W |
| TJ | Operation junction temperature -55~150 | | $^{\circ}$ |
| T _{STG} | Storage temperature range | -55~150 | ${\mathbb C}$ |

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

| Symbol | Parameter | Ratings | Unit |
|--------|---|---------|------|
| RθJA | Junction-to-Ambient Thermal Resistance ^a | 58 | °C/W |

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25 °C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.



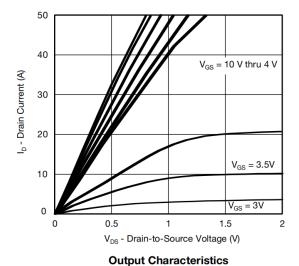
SSC8037GS6A

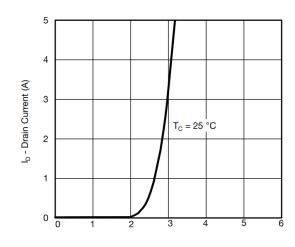
\succ Electrical Characteristics (T_A=25°C unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------------------|--------------------------------|---|------|------|------|------|
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0V, I_{D} = -250\mu A$ | -30 | | | V |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250uA$ | -1 | -1.6 | -3 | V |
| Duein Course On Besiden | Resistance R _{DS(on)} | $V_{GS} = -10V, I_D = -5A$ | | 21 | 28 | 0 |
| Drain-Source On-Resistance | | V _{GS} = -4.5V, I _D = -3A | 28 | | 42 | mΩ |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = -30V, V _{GS} = 0V | | | -1 | μΑ |
| Gate-Source Leak Current | Igss | V _{GS} = ±20V, V _{DS} = 0V | | | ±100 | nA |
| Transconductance | G _{FS} | V _{DS} = -10V, I _D = -5A | | 15 | | s |
| Forward Voltage | V _{SD} | V _{GS} = 0V, I _S = -3A | | -0.8 | -1.3 | V |
| Input Capacitance | Ciss | V 45VV 0V | | 1300 | | |
| Output Capacitance | Coss | $V_{DS} = -15V$, $V_{GS} = 0V$, $f = 1MHz$ | | 162 | | pF |
| Reverse Transfer Capacitance | C _{RSS} | T = TIVIMZ | | 183 | | |
| Turn-on Delay Time | T _{D(ON)} | | | 8.3 | | |
| Rise Time | Tr | V _{GS} = -10V, V _{DS} = -15V, | | 33.8 | | |
| Turn-off Delay Time | T _{D(OFF)} | $R_L = 3\Omega$, $R_G = 1\Omega$ | | 49 | | ns |
| Fall Time | Tf | | | 10.6 | | |
| Total Gate Charge | Q _G | 101/11/14/51/ | | 25 | | |
| Gate to Source Charge | Q _{GS} | V _{GS} = -10V, V _{DS} = -15V, | | 4.5 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = -2A | | 6.2 | | |

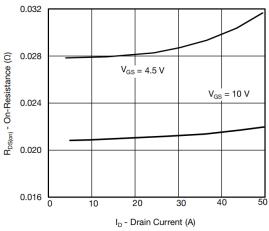


➤ Typical Performance Characteristics (T_A=25°C unless otherwise noted)

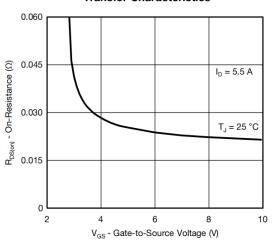




Output Onaracteristics

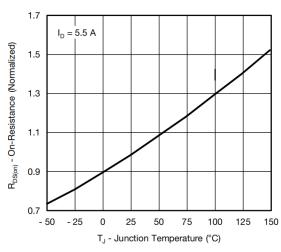


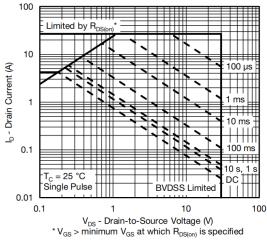
Transfer Characteristics



On-Resistance vs. Drain Current and Gate Voltage





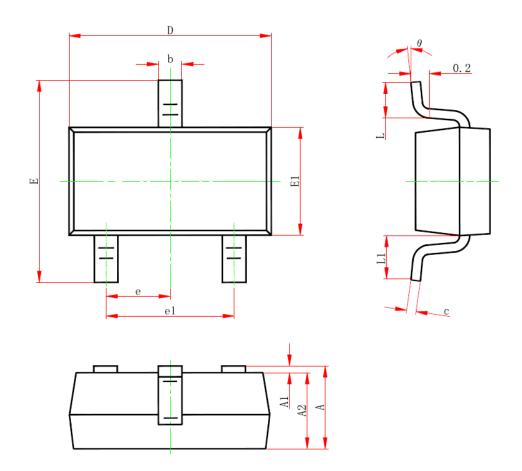


On-Resistance vs. Junction Temperature

Safe Operating Area, Junction-to-Ambient



Package Information



Package: SOT-23-3L

| C | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|------------|----------------------|------------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| Α | 1.050 | 1.250 | 0.041 | 0.049 | |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 | |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 | |
| b | 0.300 | 0.500 | 0.012 | 0.020 | |
| С | 0.100 | 0.200 | 0.004 | 0.008 | |
| D | 2.820 | 3.020 | 0.111 | 0.119 | |
| E1 | 1.500 | 1.700 | 0.059 | 0.067 | |
| E | 2.650 | 2.950 | 0.104 | 0.116 | |
| е | 0.950 | 0.950(BSC) | | 0.037(BSC) | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 | |
| L | 0.300 | 0.600 | 0.012 | 0.024 | |
| L1 | 0.600REF. | | 0.024REF. | | |
| θ | 0° | 8° | 0° | 8° | |



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